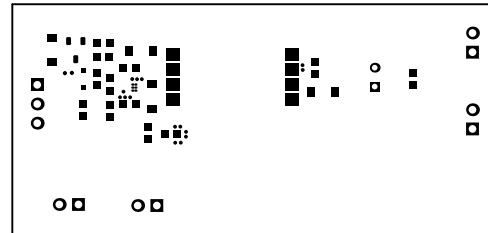
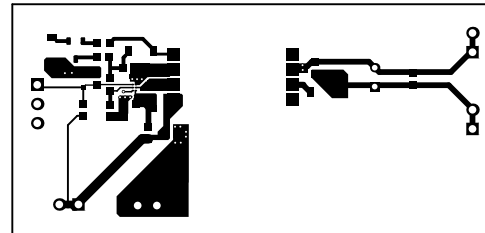


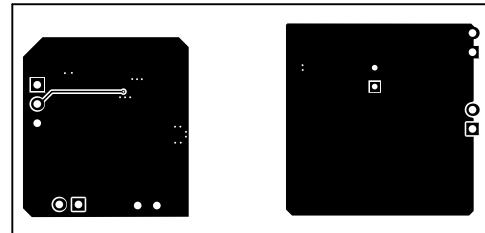
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9801	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: PMP9801		
PLOT NAME = Top Overlay	GENERATED : 9/26/2016 9:20:01 AM	TEXAS INSTRUMENTS	



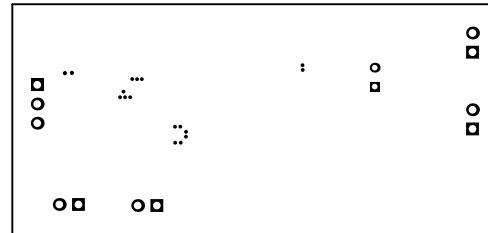
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9801	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: PMP9801		
PLOT NAME = Top Solder Mask	GENERATED : 9/26/2016 9:20:02 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9801	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: PMP9801		
PLOT NAME = Top Layer	GENERATED : 9/26/2016 9:20:03 AM	TEXAS INSTRUMENTS	

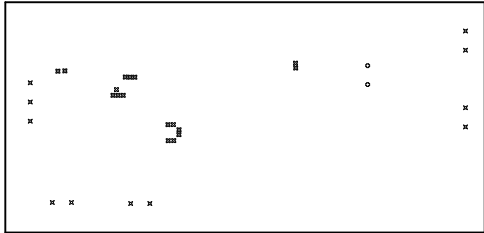


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9801	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: PMP9801		
PLOT NAME = Bottom Layer	GENERATED : 9/26/2016 9:20:04 AM	TEXAS INSTRUMENTS	

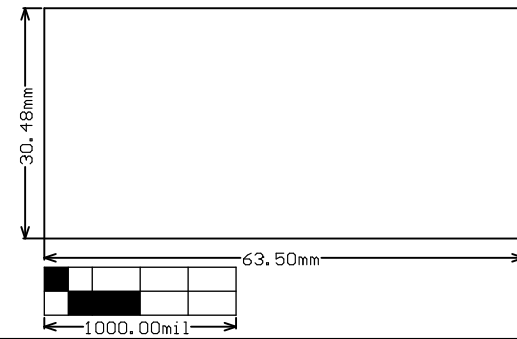


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9801	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: PMP9801		
PLOT NAME = Bottom Solder Mask	GENERATED : 9/26/2016 9:20:05 AM	TEXAS INSTRUMENTS	

Symbol	Quantity	Finished Hole Size	Plated	Hole Type
⊗	17	10.00mil (0.254mm)	PTH	Round
⊙	2	29.53mil (0.750mm)	PTH	Round
⊗	11	40.00mil (1.016mm)	PTH	Round
	30 Total			



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9801	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: PMP9801		
PLOT NAME = Drill Drawing	GENERATED : 9/26/2016 9:20:06 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9801	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: PMP9801		
PLOT NAME = Board Dimensions	GENERATED : 9/26/2016 9:20:07 AM	TEXAS INSTRUMENTS	

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